

Product Change Notification

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Product Change Notification Number: GC192801

Date 24 July 2019

Title: FPBGA Encapsulation site change for data converters

Product Identification:

EV10DS130ACZPY EV12DS130ACZPY
EV10DS130AVZPY EV12DS130AVZPY

See also https://www.teledyne-e2v.com/shared/content/resources/File/documents/Semiconductors/PCN_EOLs/GE184051_EOL.pdf

Reason for Change:

- | | | |
|---|--|--|
| <input type="checkbox"/> Design | <input type="checkbox"/> wafer Processing | <input type="checkbox"/> wafer Materials |
| <input type="checkbox"/> Logistics | <input type="checkbox"/> Other | <input checked="" type="checkbox"/> Manufacturing Location |
| <input type="checkbox"/> Process Material | <input type="checkbox"/> Assembly Material | <input type="checkbox"/> Quality/Reliability |
| | <input type="checkbox"/> Product Marking | |

Change Description:

Change of FPBGA196 subcontractor given the previous production site end of life notice.

Anticipated Impact of Product Change (Form, Fit Function):

No changes will be seen in form, fit, or function. No impact to existing datasheet

Identification Method to Distinguish Change: Based on the Date Code value.

All Date Code equal or greater than 1925 reflects the new assembly location.

P/N reference and marking information remain the same.

Qualification Data:

- available will be available in week 50/2019 not applicable

Samples:

- prototypes available will be available not applicable

Quantifiable Impact on Quality & Reliability: *None expected.*

Implementation Date*: Estimated January-2020

First Shipment with packaging originated from the new location could start from January 2020 onwards.

Exact dates might vary depending from customers' orders mix, backlog execution on the above listed product and inventory depletion

**The Estimated Implementation Date is the forecasted date that a customer may expect to receive changed product. This is determined by the estimated date of inventory depletion on the PCN issue date. This may be affected by fluctuations in supply and demand. Consequently, although customers should be prepared to receive changed product on this date, e2v semiconductors will continue to ship pre-changed product until a time in which inventory has been depleted. This may result in pre-changed product being shipped to customers after this forecasted date.*

Teledyne e2v semiconductors contact:

	Quality	Marketing
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Please contact your local Teledyne-e2v sales representative for any commercial inquiry.

APPROVAL by TRB

Teledyne e2v semiconductors will deem this change accepted unless specific conditions of acceptance are provided in writing within 30 days from the date of this notice. All correspondence must be sent to the contact e-mail addresses indicated above.

A Teledyne e2v semiconductor assumes no responsibility for any errors that may appear in this document.

The supply of products will be subject to Teledyne e2v general terms and conditions of sale or any specific contractual terms agreed between the parties.

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